

## Dual 1.5A-Peak Low-Side MOSFET Drivers

### Features

- Bipolar/CMOS/DMOS Construction
- Latch-Up Protected to >500 mA Reverse Current
- 1.5A-Peak Output Current
- 4.5V to 18V Operating Range
- Low Quiescent Supply Current
  - 4 mA at Logic 1 Input
  - 400  $\mu$ A at Logic 0 Input
- Switches 1000 pF in 25 ns
- Matched Rise and Fall Times
- 7 $\Omega$  Output Impedance
- <40 ns Typical Delay
- Logic-Input Threshold Independent of Supply Voltage
- Logic-Input Protection to -5V
- 6 pF Typical Equivalent Input Capacitance
- 25 mV Max. Output Offset from Supply or Ground
- Replaces MIC426/7/8 and MIC1426/7/8
- Dual inverting, dual non-inverting, and inverting/non-inverting configurations
- ESD Protection

### Applications

- MOSFET Driver
- Clock Line Driver
- Coax Cable Driver
- Piezoelectric Transducer Driver

### General Description

The MIC4426/4427/4428 family are highly reliable dual low-side MOSFET drivers fabricated on a BiCMOS/DMOS process for low power consumption and high efficiency. These drivers translate TTL or CMOS input logic levels to output voltage levels that swing within 25 mV of the positive supply or ground. Comparable bipolar devices are capable of swinging only to within 1V of the supply. The MIC4426/7/8 is available in three configurations: dual inverting, dual non-inverting, and one inverting plus one non-inverting output.

The MIC4426/4427/4428 are pin-compatible replacements for the MIC426/427/428 and MIC1426/1427/1428 with improved electrical performance and rugged design. They can withstand up to 500 mA of reverse current (either polarity) without latching and up to 5V noise spikes (either polarity) on ground pins.

Primarily intended for driving power MOSFETs, MIC4426/7/8 drivers are suitable for driving other loads (capacitive, resistive, or inductive) that require low-impedance, high peak current, and fast switching time. Other applications include driving heavily loaded clock lines, coaxial cables, or piezoelectric transducers. The only load limitation is that total driver power dissipation must not exceed the limits of the package.

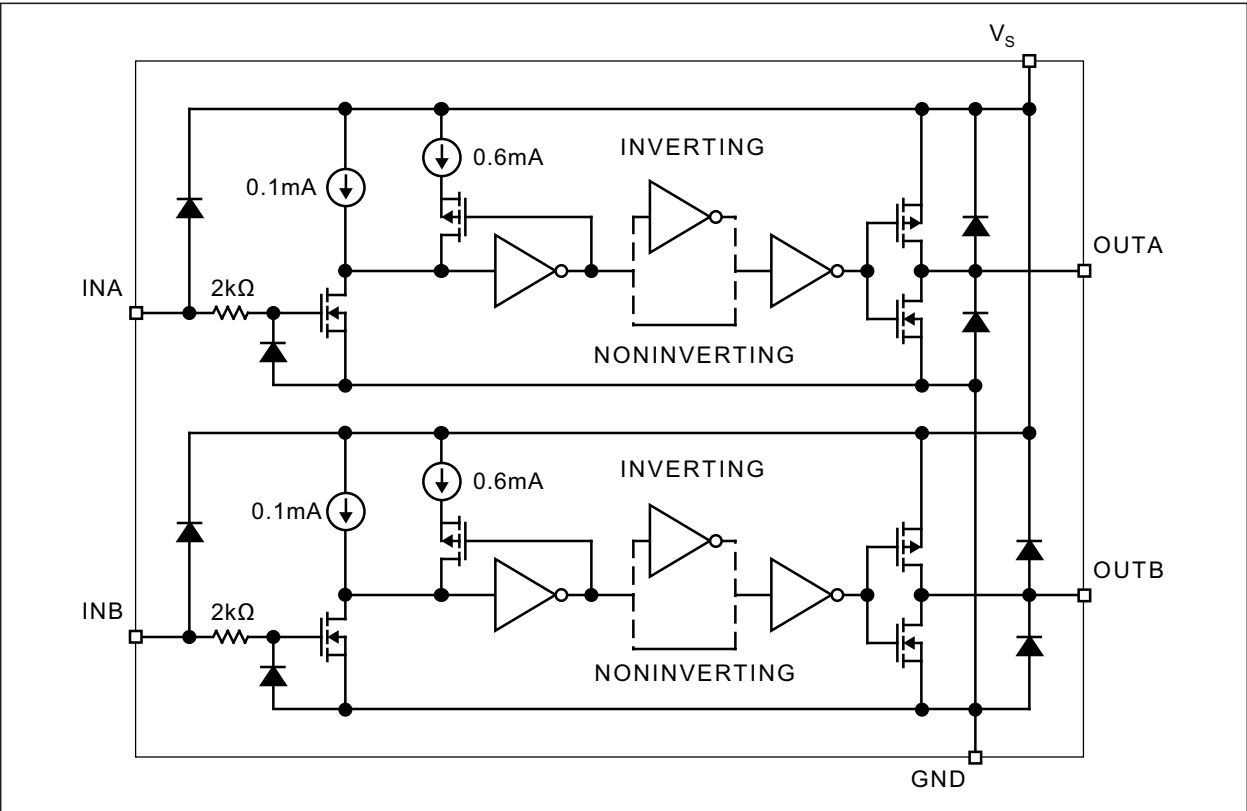
See MIC4126/4127/4128 for high power and narrow pulse applications.

### Package Types



# MIC4426/7/8

## Functional Block Diagram



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

Supply Voltage ( $V_S$ )	+22V
Input Voltage ( $V_{IN}$ )	$V_S + 0.3V$ to GND – 5V
ESD Rating	(Note 1)

### Operating Ratings ††

Supply Voltage ( $V_S$ )	+4.5V to +18V
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† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

†† **Notice:** The device is not guaranteed to function outside its operating ratings.

**Note 1:** Devices are ESD sensitive. Handling precautions are recommended.

## ELECTRICAL CHARACTERISTICS

**Electrical Characteristics:**  $4.5V \leq V_S \leq 18V$ ;  $T_A = +25^\circ C$ , **bold** values valid for full specified temperature range; unless noted. [Note 1](#)

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
<b>Input</b>						
Logic 1 Input Voltage	$V_{IH}$	2.4	1.4	—	V	—
		<b>2.4</b>	<b>1.5</b>	—		
Logic 0 Input Voltage	$V_{IL}$	—	1.1	0.8	V	—
		—	<b>1.0</b>	<b>0.8</b>		
Input Current	$I_{IN}$	<b>-1</b>	—	<b>1</b>	$\mu A$	$0V \leq V_{IN} \leq V_S$
<b>Output</b>						
High Output Voltage	$V_{OH}$	$V_S -$ <b>0.025</b>	—	—	V	—
Low Output Voltage	$V_{OL}$	—	—	<b>0.025</b>	V	—
Output Resistance	$R_O$	—	6	10	$\Omega$	$I_{OUT} = 10\text{ mA}, V_S = 18V$
		—	<b>8</b>	<b>12</b>		
Peak Output Current	$I_{PK}$	—	<b>1.5</b>	—	A	—
Latch-Up Protection	I	<b>&gt;500</b>	—	—	mA	Withstand Reverse Current
<b>Switching Time</b>						
Rise Time	$t_r$	—	18	30	ns	Test <a href="#">Figure 1-1</a>
		—	<b>20</b>	<b>40</b>		—
Fall Time	$t_f$	—	15	20	ns	Test <a href="#">Figure 1-1</a>
		—	<b>29</b>	<b>40</b>		—
Delay Time	$t_{D1}$	—	17	30	ns	Test <a href="#">Figure 1-1</a>
		—	<b>19</b>	<b>40</b>		—
Delay Time	$t_{D2}$	—	23	50	ns	Test <a href="#">Figure 1-1</a>
		—	<b>27</b>	<b>60</b>		—

**Note 1:** Specification for packaged product only.

# MIC4426/7/8

## ELECTRICAL CHARACTERISTICS (CONTINUED)

**Electrical Characteristics:**  $4.5V \leq V_S \leq 18V$ ;  $T_A = +25^\circ C$ , **bold** values valid for full specified temperature range; unless noted. [Note 1](#)

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Pulse Width	$t_{PW}$	<b>400</b>	—	—	ns	Test <a href="#">Figure 1-1</a>
<b>Power Supply</b>						
Power Supply Current	$I_S$	0.6	1.4	4.5	mA	$V_{INA} = V_{INB} = 3.0V$
		—	<b>1.5</b>	<b>8</b>		—
Power Supply Current	$I_S$	—	0.18	0.4	mA	$V_{INA} = V_{INB} = 0V$
		—	<b>0.19</b>	<b>0.6</b>		—

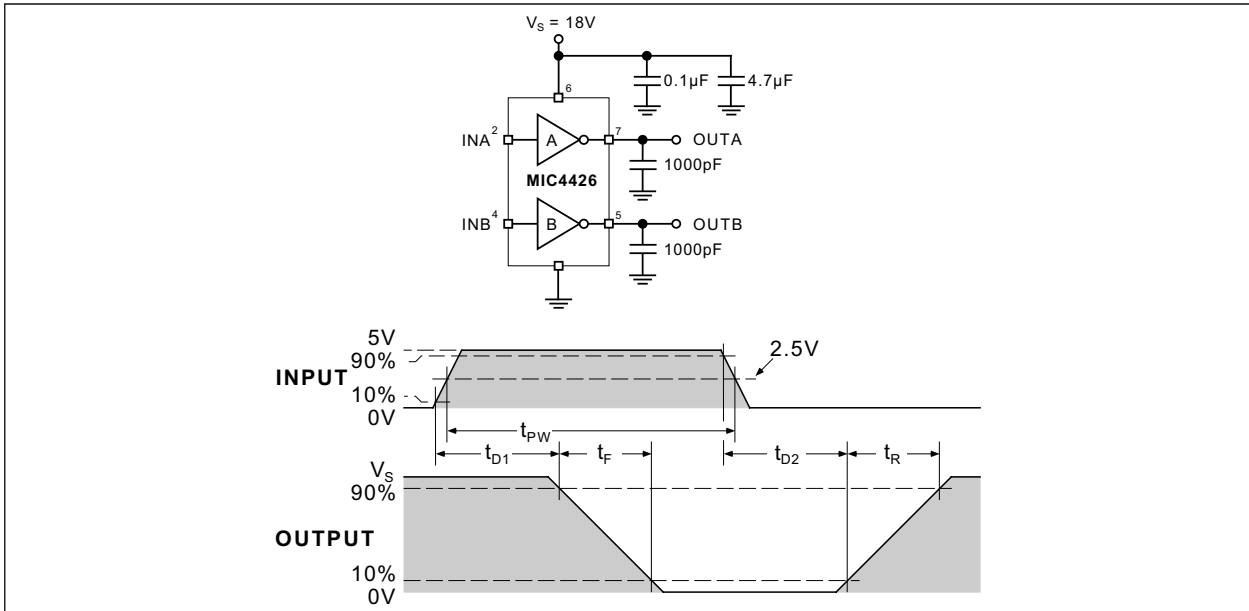
**Note 1:** Specification for packaged product only.

## TEMPERATURE SPECIFICATIONS

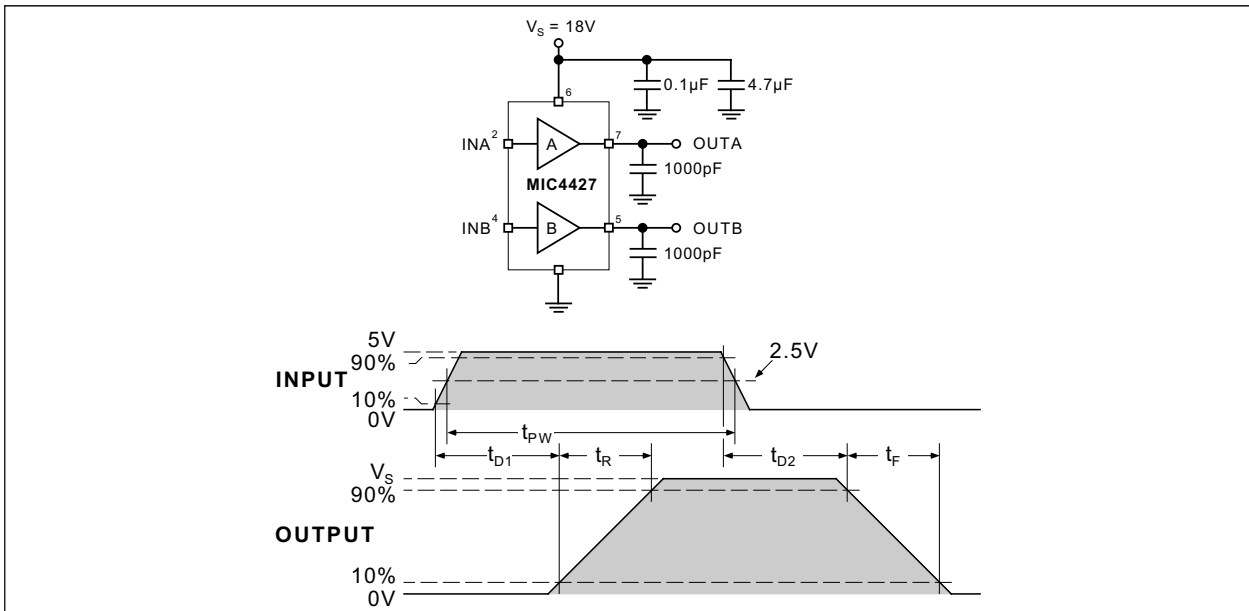
Parameters	Sym.	Min.	Typ.	Max.	Units	Conditions
<b>Temperature Ranges</b>						
Maximum Junction Temperature	$T_J$	—	—	+150	$^\circ C$	—
Storage Temperature Range	$T_S$	-65	—	+150	$^\circ C$	—
Lead Temperature	—	—	—	+300	$^\circ C$	10 sec.
Junction Operating Temperature Range	$T_J$	0	—	+70	$^\circ C$	Z option
Junction Operating Temperature Range	$T_J$	-40	—	+85	$^\circ C$	Y option
<b>Package Thermal Resistances</b>						
Thermal Resistance, PDIP 8-Ld	$\theta_{JA}$	—	130	—	$^\circ C/W$	—
Thermal Resistance, PDIP 8-Ld	$\theta_{JC}$	—	42	—	$^\circ C/W$	—
Thermal Resistance, SOIC 8-Ld	$\theta_{JA}$	—	120	—	$^\circ C/W$	—
Thermal Resistance, SOIC 8-Ld	$\theta_{JC}$	—	75	—	$^\circ C/W$	—
Thermal Resistance, MSOP 8-Ld	$\theta_{JA}$	—	250	—	$^\circ C/W$	—

**Note 1:** The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e.,  $T_A$ ,  $T_J$ ,  $\theta_{JA}$ ). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125 $^\circ C$  rating. Sustained junction temperatures above +125 $^\circ C$  can impact the device reliability.

## Test Circuits



**FIGURE 1-1:** Inverting Driver Switching Time.

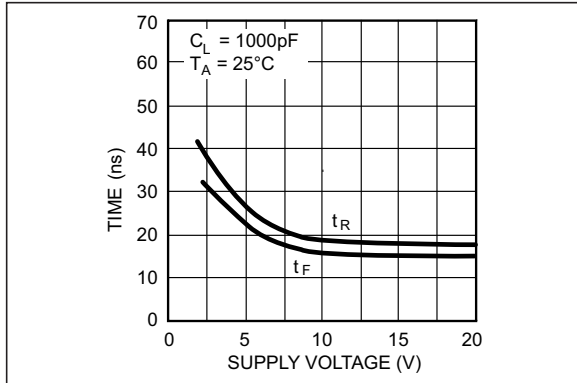


**FIGURE 1-2:** Non-Inverting Driver Switching Time.

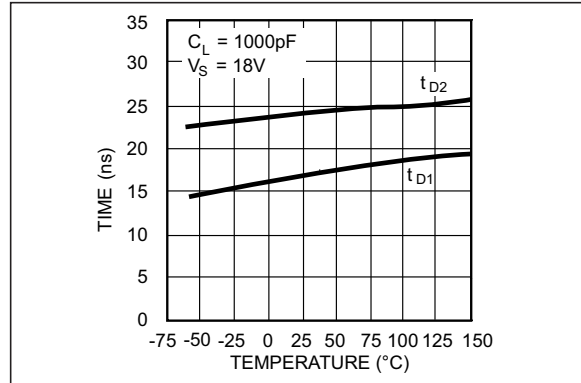
# MIC4426/7/8

## 2.0 TYPICAL PERFORMANCE CURVES

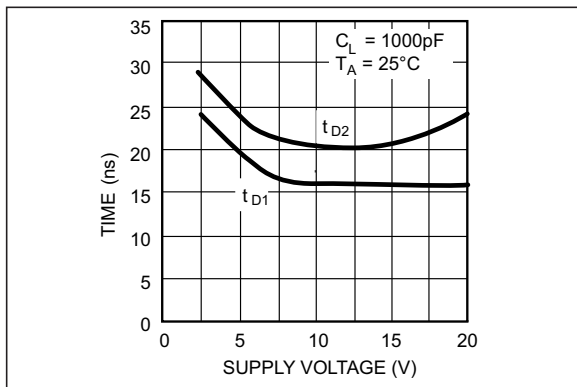
**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



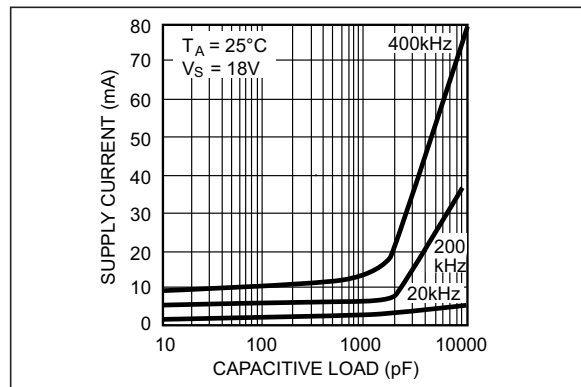
**FIGURE 2-1:** Rise and Fall Time vs. Supply Voltage.



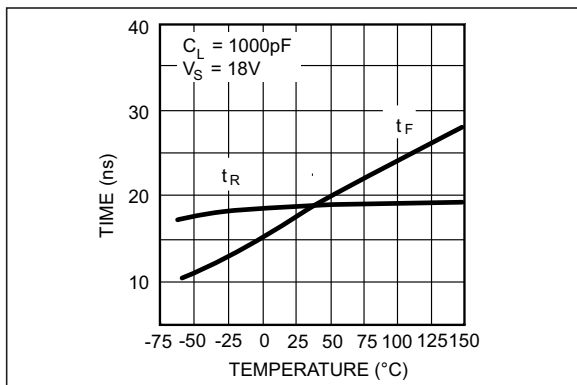
**FIGURE 2-4:** Delay Time vs. Temperature.



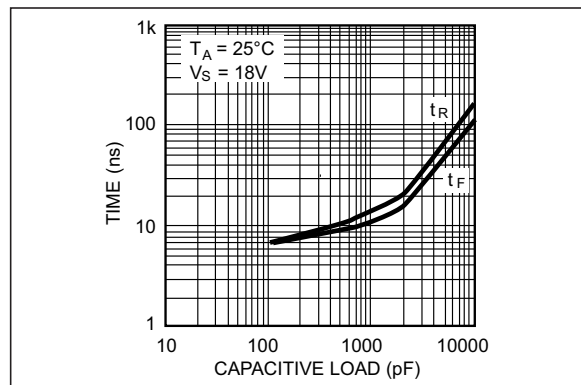
**FIGURE 2-2:** Delay Time vs. Supply Voltage.



**FIGURE 2-5:** Supply Current vs. Capacitive Load.



**FIGURE 2-3:** Rise and Fall Time vs. Temperature.



**FIGURE 2-6:** Rise and Fall Time vs. Capacitive Load.



**FIGURE 2-7:** Supply Current vs. Frequency.



**FIGURE 2-10:** Quiescent Power Supply Current vs. Supply Voltage.



**FIGURE 2-8:** High Output vs. Current.



**FIGURE 2-11:** Quiescent Power Supply Current vs. Supply Voltage.



**FIGURE 2-9:** Low Output vs. Current.



**FIGURE 2-12:** Package Power Dissipation.

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## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in [Table 3-1](#).

**TABLE 3-1: PIN FUNCTION TABLE**

Pin Number	Pin Name	Description
1, 8	NC	Not internally connected.
2	INA	Control Input A: TTL/CMOS compatible logic input.
3	GND	Ground.
4	INB	Control Input B: TTL/CMOS compatible logic input.
5	OUTB	Output B: CMOS totem-pole output.
6	VS	Supply Input: +4.5V to +18V.
7	OUTA	Output A: CMOS totem-pole output.

## 4.0 APPLICATION INFORMATION

### 4.1 Supply Bypassing

Large currents are required to charge and discharge large capacitive loads quickly. For example, changing a 1000 pF load by 16V in 25 ns requires 0.8A from the supply input.

To guarantee low supply impedance over a wide frequency range, parallel capacitors are recommended for power supply bypassing. Low-inductance ceramic MLC capacitors with short lead lengths (< 0.5") should be used. A 1.0 μF film capacitor in parallel with one or two 0.1 μF ceramic MLC capacitors normally provides adequate bypassing.

### 4.2 Grounding

When using the inverting drivers in the MIC4426 or MIC4428, individual ground returns for the input and output circuits or a ground plane are recommended for optimum switching speed. The voltage drop that occurs between the driver's ground and the input signal ground, during normal high-current switching, will behave as negative feedback and degrade switching speed.

### 4.3 Control Input

Unused driver inputs must be connected to logic high (which can be VS) or ground. For the lowest quiescent current (<500 μA), connect unused inputs to ground. A logic high signal will cause the driver to draw up to 9 mA.

The drivers are designed with 100 mV of control input hysteresis. This provides clean transitions and minimizes output stage current spikes when changing states. The control input voltage threshold is approximately 1.5V. The control input recognizes 1.5V up to VS as a logic high and draws less than 1 μA within this range.

The MIC4426/7/8 drives the TL494, SG1526/7, MIC38C42, TSC170, and similar switch-mode power supply integrated circuits.

### 4.4 Power Dissipation

Power dissipation should be calculated to make sure that the driver is not operated beyond its thermal ratings. Quiescent power dissipation is negligible. A practical value for total power dissipation is the sum of the dissipation caused by the load and the transition power dissipation ( $P_L + P_T$ ).

### 4.5 Load Dissipation

Power dissipation caused by continuous load current (when driving a resistive load) through the driver's output resistance is:

#### EQUATION 4-1:

$$P_L = I_L^2 \times R_O$$

For capacitive loads, the dissipation in the driver is:

#### EQUATION 4-2:

$$P_L = f \times C_L \times V_S^2$$

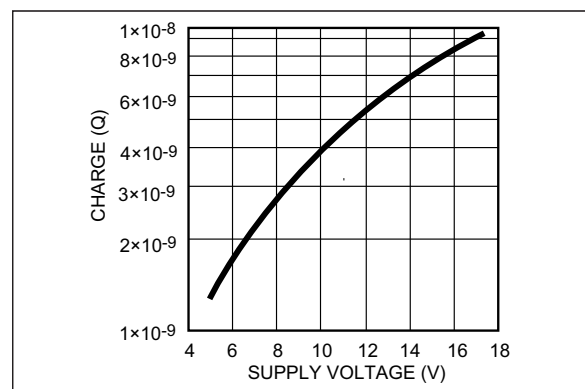
### 4.6 Power Dissipation

In applications switching at a high frequency, transition power dissipation can be significant. This occurs during switching transitions when the P-channel and N-channel output FETs are both conducting for the brief moment when one is turning on and the other is turning off.

#### EQUATION 4-3:

$$P_T = 2 \times f \times V_S \times Q$$

Charge (Q) is read from the following graph:



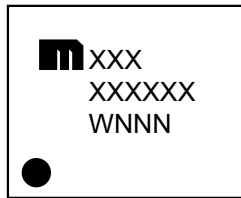
**FIGURE 4-1:** Crossover Energy Loss per Transition.

# MIC4426/7/8

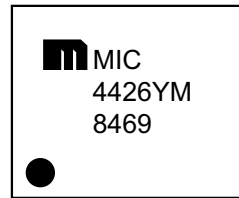
## 5.0 PACKAGING INFORMATION

### 5.1 Package Marking Information

#### 8-Lead SOIC\*



#### Example



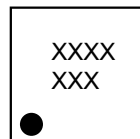
#### 8-Lead PDIP\*



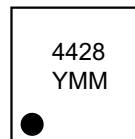
#### Example



#### 8-Lead MSOP\*



#### Example



<b>Legend:</b>	XX...X	Product code or customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
	•, ▲, ▼	Pin one index is identified by a dot, delta up, or delta down (triangle mark).
<b>Note:</b>	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.	
	Underbar (¯) and/or Overbar (¯) symbol may not be to scale.	

## 8-Lead SOICN Package Outline & Recommended Land Pattern

**TITLE**

8 LEAD SOICN PACKAGE OUTLINE & RECOMMENDED LAND PATTERN

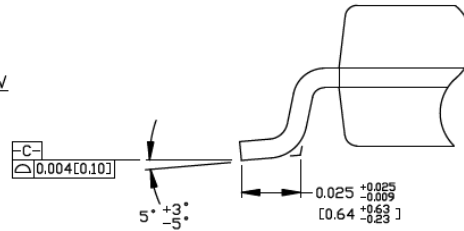
DRAWING #	SOICN-8LD-PL-1	UNIT	INCH [MM]
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TOP VIEW



BOTTOM VIEW



DETAIL "A"



END VIEW



RECOMMENDED LAND PATTERN

**NOTES:**

1. DIMENSIONS ARE IN INCHES[MM].
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.010[0.25] PER SIDE.

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>.

# MIC4426/7/8

## 8-Lead PDIP Package Outline and Recommended Land Pattern

**TITLE**

8 LEAD PDIP PACKAGE OUTLINE & RECOMMENDED LAND PATTERN

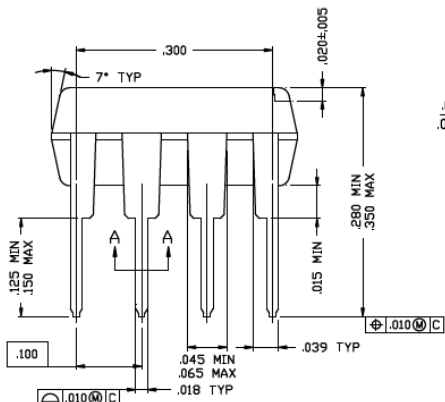
<b>DRAWING #</b>	PDIP-8LD-PL-1	<b>UNIT</b>	INCH
<b>Lead Frame</b>	Copper	<b>Lead Finish</b>	Matte Tin



TOP VIEW



END VIEW



SIDE VIEW



SECTION A-A

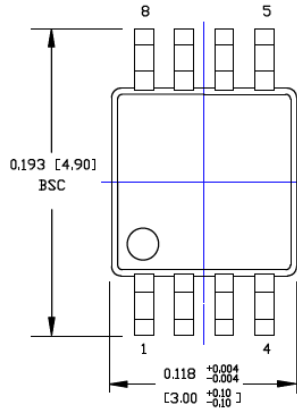
Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>.

## 8-Lead MSOP Package Outline and Recommended Land Pattern

**TITLE**

8 LEAD MSOP PACKAGE OUTLINE & RECOMMENDED LAND PATTERN

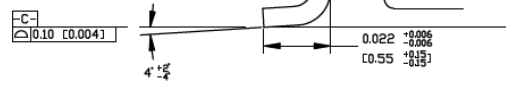
DRAWING #	MSOP-8LD-PL-1	UNIT	INCH [MM]
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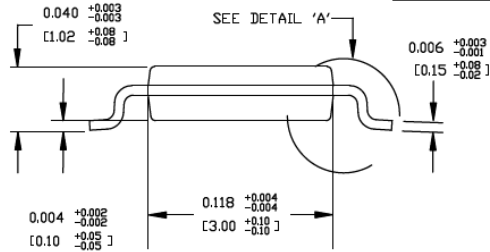
TOP VIEW



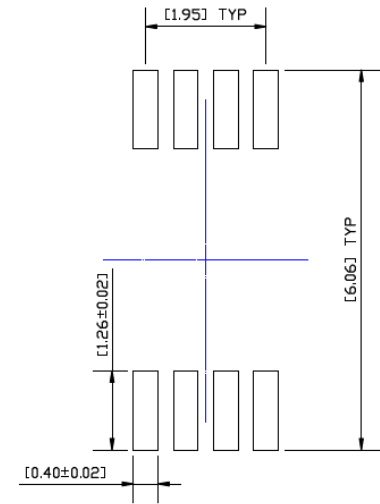
BOTTOM VIEW



DETAIL A



SIDE VIEW



RECOMMENDED LAND PATTERN

**NOTES:**

1. DIMENSIONS ARE IN INCHES [MM].
2. CONTROLLING DIMENSION: MM.
3. DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.008 [0.20] PER SIDE.

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>.

# MIC4426/7/8

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NOTES:

## APPENDIX A: REVISION HISTORY

### Revision A (May 2019)

- Converted Micrel document MIC4426/7/8 to Microchip data sheet template DS20006202A.
- Minor grammatical text changes throughout.

# MIC4426/7/8

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NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

Device	X	XX	-XX
Part No.	Junction Temp. Range	Package	Media Type
<b>Device:</b>	MIC4426:	Dual Inverting, Dual 1.5A-Peak Low-Side MOSFET Driver	
	MIC4427:	Dual Non-Inverting, Dual 1.5A-Peak Low-Side MOSFET Driver	
	MIC4428:	Inverting and Non-Inverting, Dual 1.5A-Peak Low-Side MOSFET Driver	
<b>Junction Temperature Range:</b>	Y =	-40°C to +85°C, RoHS-Compliant	
	Z =	0°C to +70°C, RoHS-Compliant	
<b>Package:</b>	N =	8-Lead PDIP	
	M =	8-Lead SOIC	
	MM =	8-Lead MSOP	
<b>Media Type:</b>	<blank>=	95/Tube (SOIC only)	
	<blank>=	100/Tube (MSOP only)	
	<blank>=	50/Tube (PDIP only)	
	TR =	2,500/Reel (SOIC only)	
<b>Examples:</b>			
a) MIC4426: Dual Inverting, Dual 1.5A-Peak Low-Side MOSFET Driver, -40°C to +85°C Temp. Range			
	MIC4426YM	8-Lead SOIC	95/Tube
	MIC4426YM-TR	8-Lead SOIC	2,500/Reel
	MIC4426YN	8-Lead PDIP	50/Tube
	MIC4426YMM	8-Lead MSOP	100/Tube
	MIC4426YMM-TR	8-Lead MSOP	2,500/Reel
b) MIC4426: Dual Inverting, Dual 1.5A-Peak Low-Side MOSFET Driver, 0°C to +70°C Temp. Range			
	MIC4426ZN	8-Lead PDIP	50/Tube
	MIC4426ZM	8-Lead SOIC	95/Tube
	MIC4426ZM-TR	8-Lead SOIC	2,500/Reel
c) MIC4427: Dual Non-Inverting, Dual 1.5A-Peak Low-Side MOSFET Driver, -40°C to +85°C Temp. Range			
	MIC4427YM	8-Lead SOIC	95/Tube
	MIC4427YM-TR	8-Lead SOIC	2,500/Reel
	MIC4427YN	8-Lead PDIP	50/Tube
	MIC4427YMM	8-Lead MSOP	100/Tube
	MIC4427YMM-TR	8-Lead MSOP	2,500/Reel
d) MIC4427: Dual Non-Inverting, Dual 1.5A-Peak Low-Side MOSFET Driver, 0°C to +70°C Temp. Range			
	MIC4427ZN	8-Lead PDIP	50/Tube
	MIC4427ZM	8-Lead SOIC	95/Tube
	MIC4427ZM-TR	8-Lead SOIC	2,500/Reel
e) MIC4428: Inverting + Non-Inverting, Dual 1.5A-Peak Low-Side MOSFET Driver, -40°C to +85°C Temp. Range			
	MIC4428YM	8-Lead SOIC	95/Tube
	MIC4428YM-TR	8-Lead SOIC	2,500/Reel
	MIC4428YN	8-Lead PDIP	50/Tube
	MIC4428YMM	8-Lead MSOP	100/Tube
	MIC4428YMM-TR	8-Lead MSOP	2,500/Reel
f) MIC4428: Inverting + Non-Inverting, Dual 1.5A-Peak Low-Side MOSFET Driver, 0°C to +70°C Temp. Range			
	MIC4428ZN	8-Lead PDIP	50/Tube
	MIC4428ZM	8-Lead SOIC	95/Tube
	MIC4428ZM-TR	8-Lead SOIC	2,500/Reel
<b>Note 1:</b> Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.			

# MIC4426/7/8

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NOTES:

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- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
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- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as “unbreakable.”

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**QUALITY MANAGEMENT SYSTEM  
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